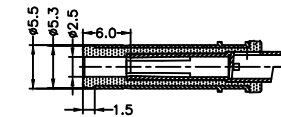


REV.	ECN NO OR DESCRIPTION	REVISED	DATE
E	ECN NO: S081005	BOYE	2008.11.24
F	ECN NO.S090203	LILI	2009.04.15
G	ECN NO.S150941-E	YUREN	2015.12.11
H	ECN NO.S202009-R12	Kesheng	2021.03.17

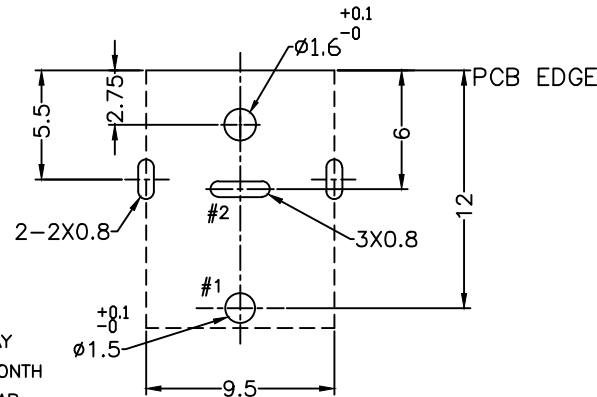
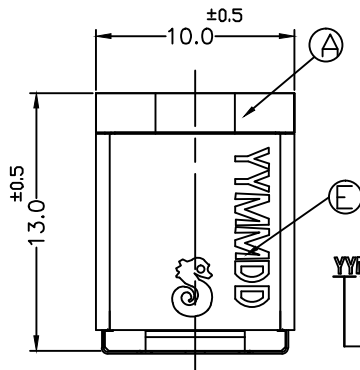
- SPECIFICATIONS:
- RATING: DC 20V 10A 44uF
  - INSERTION FORCE: 3Kg MAX.  
WITHDRAWAL FORCE: 1.0Kg~3Kg
  - INSULATION RESISTANCE BETWEEN ANY ADJACENT TERMINALS SHALL NOT BE LESS THAN 100 MEGOHMS BY 500 VOLTS MEGGER
  - JACK SHALL WITHSTAND 250 VOLTS BETWEEN ANY ADJACENT TERMINAL FOR ONE MINUTE.
  - CONTACT RESISTANCE (INITIAL) SHALL NOT EXCEED 30mΩ  
CONTACT RESISTANCE (AFTER LIFE TEST) SHALL NOT EXCEED 50mΩ  
ABOVE MUST USE 2DP-G213-B04 PLUG
  - MEASURING CONDITION:  
TEMPERATURE: FROM 5°C TO 35°C.  
RELATIVE HUMIDITY: FROM 40% TO 85%.
  - ENVIRONMENTAL SPECIFICATIONS:  
7.1 HUMIDITY TEST: HUMIDITY 90% TO 95% TEMPERATURE 40°C ±2°C FOR 96 HOURS.  
7.2 HEAT TEST: TEMPERATURE 70°C ± 2°C (HUMIDITY BELOW 50%) FOR 96 HOURS.  
7.3 COLD TEST: TEMPERATURE -40°C ± 2°C FOR 96 HOURS.
  - MATING PLUG : SINGATRON'S P/N : 2DP-G213-B04(PLUG SET)
  - PACKAGING: TAPE & REEL
  - PRINTED DATE CODE "YYMMDD" ON TOP OF CONNECTOR.
  - RATING: DC 20V 10A 44uF DEPEND ON MATING PLUG DETAIL TYPE
  - WEIGHT: 2.9 g/pcs
  - FOR REFLOW SOLDERING LEAD-FREE PROCESS.



05.5 PULG TYPE(2DP-G213-B04)  
1.RATING: DC 20V 10A 44uF

F	GROUND	1	SUS 304 0.15t	N/A
E	SHELL	1	SPCC-SD 0.4t	Ni 60u" Min.
D	STOPPER	1	HIGH TEMP.THERMOPLASTIC UL94V-0	NATURE
C	PIN	1	HBI59-1.5B	Gold Flash Over Ni 50u" Min.
B	SPRING	1	COPPER ALLOY 0.3t	Sn 60u"Min,Ni 60u"Min.
A	BODY	1	HIGH TEMP.THERMOPLASTIC UL94V-0	BLACK
NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR

UNLESS OTHERWISE SPECIFIED TOLERANCES		Singatron Enterprise Co., Ltd. 信音企業股份有限公司	
DECIMALS:	ANGLES:	TITLE	
X :±0.5	X :±2°	DWN	Kesheng
X.X :±0.3	X.X :±1°	CHKD	Sky
X.XX :±0.2		APVD	Lussen
		<b>PART NO.2DC-G213-B26</b> SCALE:4:1 UNIT: mm SIZE: A3 SHEET:1 OF 1 REV:H <b>CUSTOMER COPY</b>	



RECOMMEND P.C.B LAYOUT  
TOP VIEW (TOLERANCE ±0.05)

